



notes:

Final copper thicknesses according to IPC-6012

Standard: Surface Finish ENIG  
(Ni 5.5 µm ± 1.5 µm, Au 0.075 µm ± 0.025 µm)

Please follow our sectional design rules:  
► [www.we-online.com/designrules/shdi\\_en](http://www.we-online.com/designrules/shdi_en)

For impedance matching stackups: Please consult our specialists: [HDI@we-online.com](mailto:HDI@we-online.com)

**HDI8\_3-2I4b-3\_161\_35\_2V13**

PCB Thickness Tolerance: ± 10%

customer		created	
pcb name		approved	
engineer		format	A4, landscape
date			

Template Revision: 10/2023 by Andreas Schilpp / Michael Kress / Werner Öchslen



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ELEKTRONIK**  
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